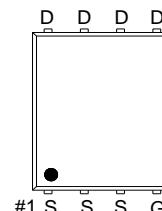
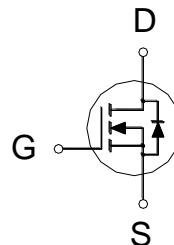


NIKO-SEM
**N-Channel Enhancement Mode
Field Effect Transistor**
PG1010BK
PDFN 5x6P
Halogen-Free & Lead-Free
PRODUCT SUMMARY

| $V_{(BR)DSS}$ | $R_{DS(ON)}$ | I_D |
|---------------|--------------|-------|
| 100V | 10mΩ | 58A |


G. GATE
D. DRAIN
S. SOURCE
ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS | | SYMBOL | LIMITS | UNITS |
|--|---------------------------|----------------|------------|-------|
| Drain-Source Voltage | | V_{DS} | 100 | V |
| Gate-Source Voltage | | V_{GS} | ± 20 | V |
| Continuous Drain Current | $T_C = 25^\circ\text{C}$ | I_D | 58 | A |
| | $T_C = 100^\circ\text{C}$ | | 41 | |
| Pulsed Drain Current ¹ | | I_{DM} | 120 | A |
| Continuous Drain Current | $T_A = 25^\circ\text{C}$ | I_D | 14.7 | |
| | $T_A = 70^\circ\text{C}$ | | 12 | |
| Avalanche Current | | I_{AS} | 12.5 | |
| Avalanche Energy | $L = 1\text{mH}$ | E_{AS} | 78.1 | mJ |
| Power Dissipation | $T_C = 25^\circ\text{C}$ | P_D | 78 | W |
| | $T_C = 100^\circ\text{C}$ | | 39 | |
| Power Dissipation ³ | $T_A = 25^\circ\text{C}$ | P_D | 5 | W |
| | $T_A = 70^\circ\text{C}$ | | 3.5 | |
| Operating Junction & Storage Temperature Range | | T_j, T_{stg} | -55 to 175 | °C |

THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE | | SYMBOL | TYPICAL | MAXIMUM | UNITS |
|----------------------------------|---------------------|-----------------|-------------------------------|---------|-------------------------------|
| Junction-to-Ambient ² | $t \leq 10\text{s}$ | $R_{\theta JA}$ | $^{\circ}\text{C} / \text{W}$ | 30 | $^{\circ}\text{C} / \text{W}$ |
| Junction-to-Ambient ² | Steady-State | $R_{\theta JA}$ | | 60 | |
| Junction-to-Case | Steady-State | $R_{\theta JC}$ | | 1.9 | |

¹Pulse width limited by maximum junction temperature.²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.³The Power dissipation is based on $R_{\theta JA}$ $t \leq 10\text{s}$ value.

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ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, Unless Otherwise Noted)

| PARAMETER | SYMBOL | TEST CONDITIONS | LIMITS | | | UNIT |
|---|-----------------------------|--|--------|------|-----------|------------------|
| | | | MIN | TYP | MAX | |
| STATIC | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(\text{BR})\text{DSS}}$ | $V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$ | 100 | | | V |
| Gate Threshold Voltage | $V_{\text{GS}(\text{th})}$ | $V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$ | 1.4 | 2 | 3 | |
| Gate-Body Leakage | I_{GSS} | $V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 20\text{V}$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{\text{DS}} = 100\text{V}, V_{\text{GS}} = 0\text{V}$ | | | 1 | |
| | | $V_{\text{DS}} = 100\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 125^\circ\text{C}$ | | | 100 | μA |
| Drain-Source On-State Resistance ¹ | $R_{\text{DS}(\text{ON})}$ | $V_{\text{GS}} = 10\text{V}, I_D = 12\text{A}$ | | 8 | 10 | $\text{m}\Omega$ |
| | | $V_{\text{GS}} = 4.5\text{V}, I_D = 10\text{A}$ | | 11 | 14.5 | |
| Forward Transconductance ¹ | g_{fs} | $V_{\text{DS}} = 5\text{V}, I_D = 12\text{A}$ | | 53 | | S |
| DYNAMIC | | | | | | |
| Input Capacitance | C_{iss} | $V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 50\text{V}, f = 1\text{MHz}$ | | 2183 | | pF |
| Output Capacitance | C_{oss} | | | 190 | | |
| Reverse Transfer Capacitance | C_{rss} | | | 13 | | |
| Gate Resistance | R_g | $V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 0\text{V}, f = 1\text{MHz}$ | | 1.5 | | Ω |
| Total Gate Charge ² | Q_g | $V_{\text{GS}} = 10\text{V}$ $V_{\text{GS}} = 4.5\text{V}$ | | 40 | | nC |
| | | | | 22 | | |
| Gate-Source Charge ² | Q_{gs} | $V_{\text{DS}} = 50\text{V}, V_{\text{GS}} = 10\text{V}, I_D = 12\text{A}$ | | 7 | | nC |
| Gate-Drain Charge ² | Q_{gd} | | | 11 | | |
| Turn-On Delay Time ² | $t_{\text{d}(\text{on})}$ | | | 15 | | |
| Rise Time ² | t_r | | | 42 | | |
| Turn-Off Delay Time ² | $t_{\text{d}(\text{off})}$ | $V_{\text{DS}} = 50\text{V}, I_D \approx 12\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 6\Omega$ | | 53 | | nS |
| Fall Time ² | t_f | | | 65 | | |
| SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ\text{C}$) | | | | | | |
| Continuous Current | I_S | | | | 58 | A |
| Forward Voltage ¹ | V_{SD} | $I_F = 12\text{A}, V_{\text{GS}} = 0\text{V}$ | | | 1.2 | V |
| Reverse Recovery Time | t_{rr} | $I_F = 12\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$ | | 32 | | nS |
| Reverse Recovery Charge | Q_{rr} | | | 40 | | nC |

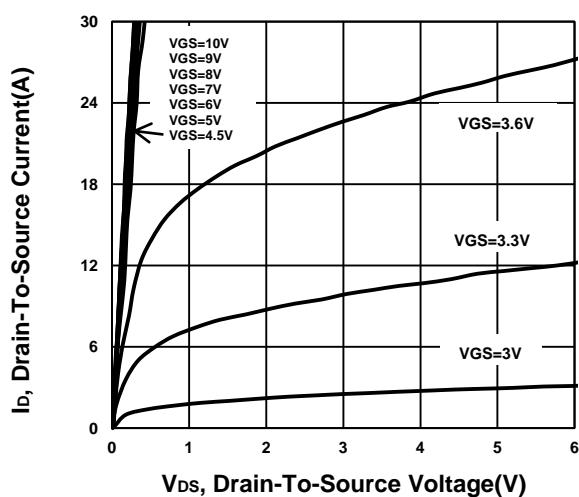
¹Pulse test : Pulse Width $\leq 300\ \mu\text{sec}$, Duty Cycle $\leq 2\%$.²Independent of operating temperature.

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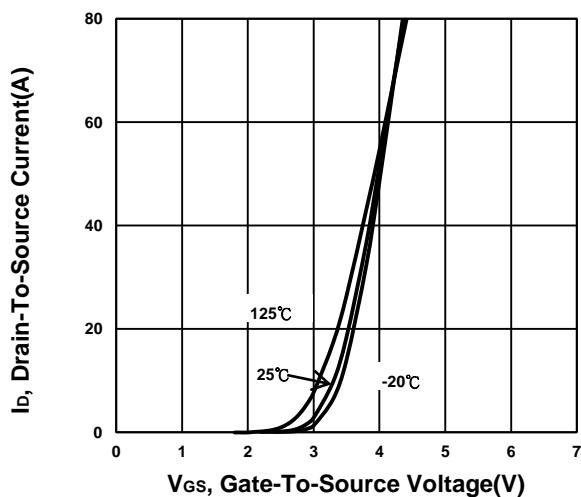
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Field Effect Transistor**

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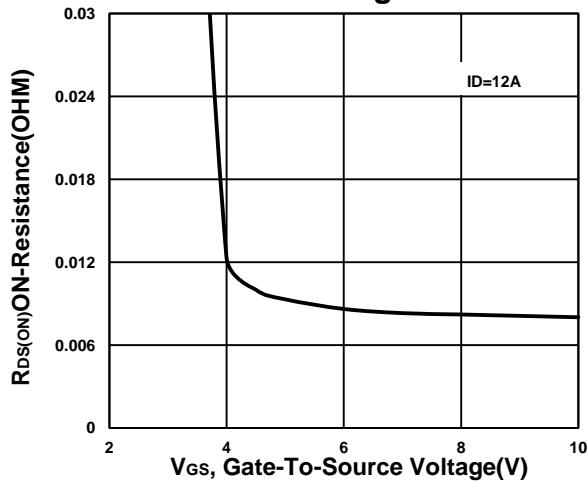
Output Characteristics



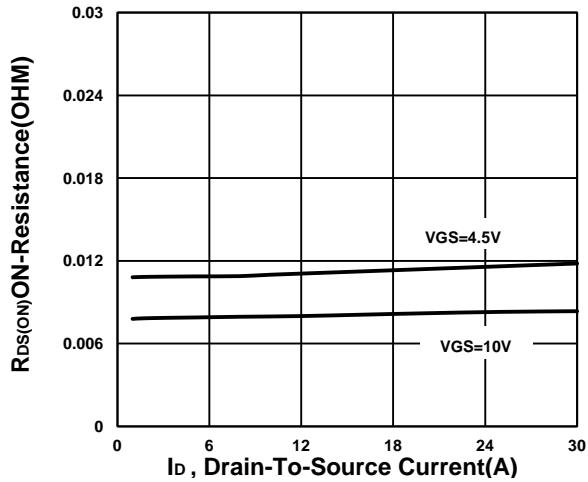
Transfer Characteristics



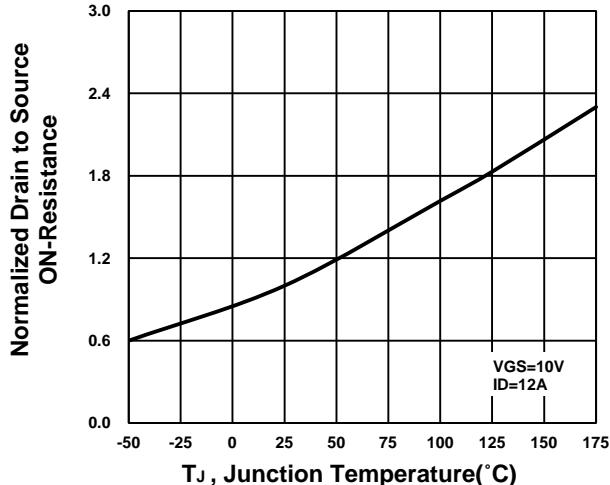
On-Resistance VS Gate-To-Source Voltage



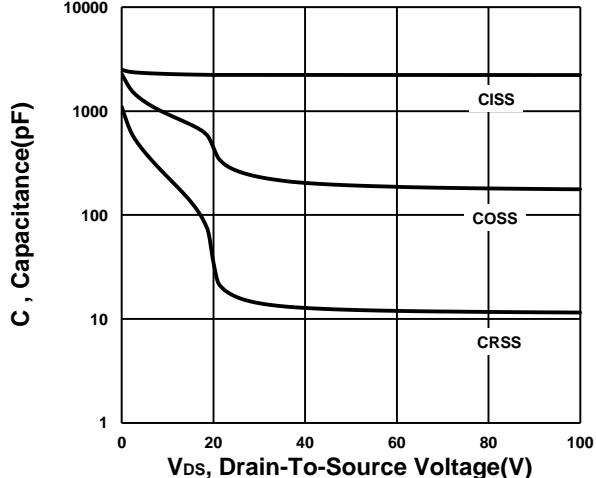
On-Resistance VS Drain Current

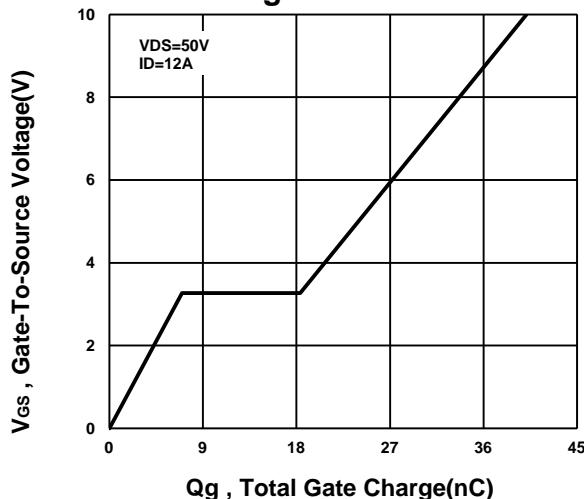
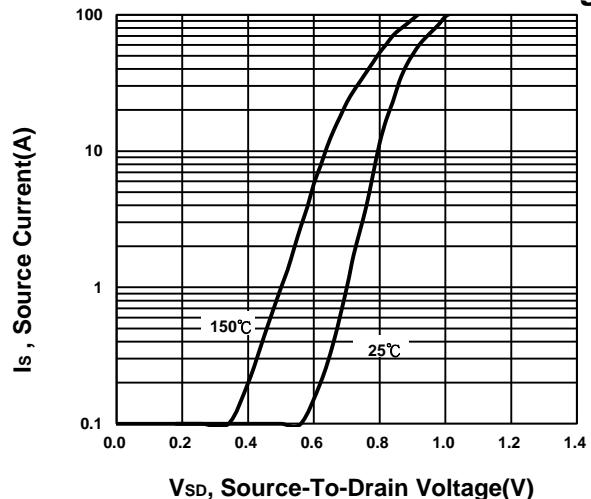
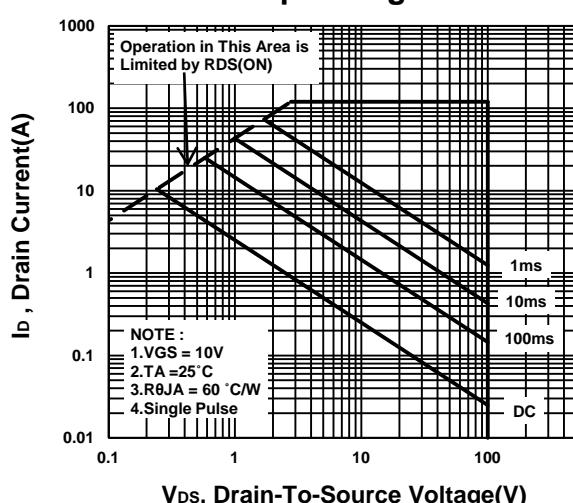
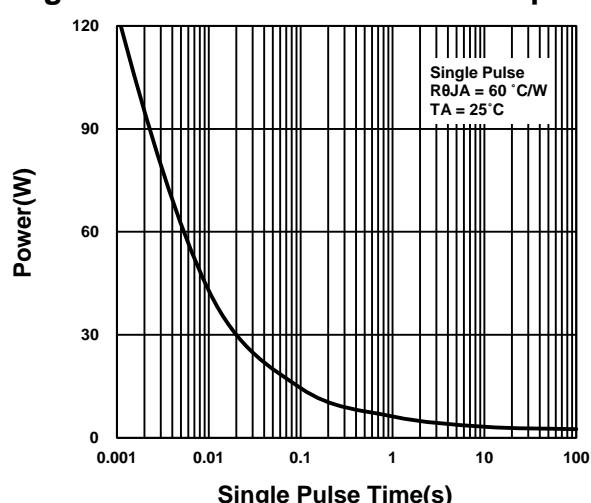
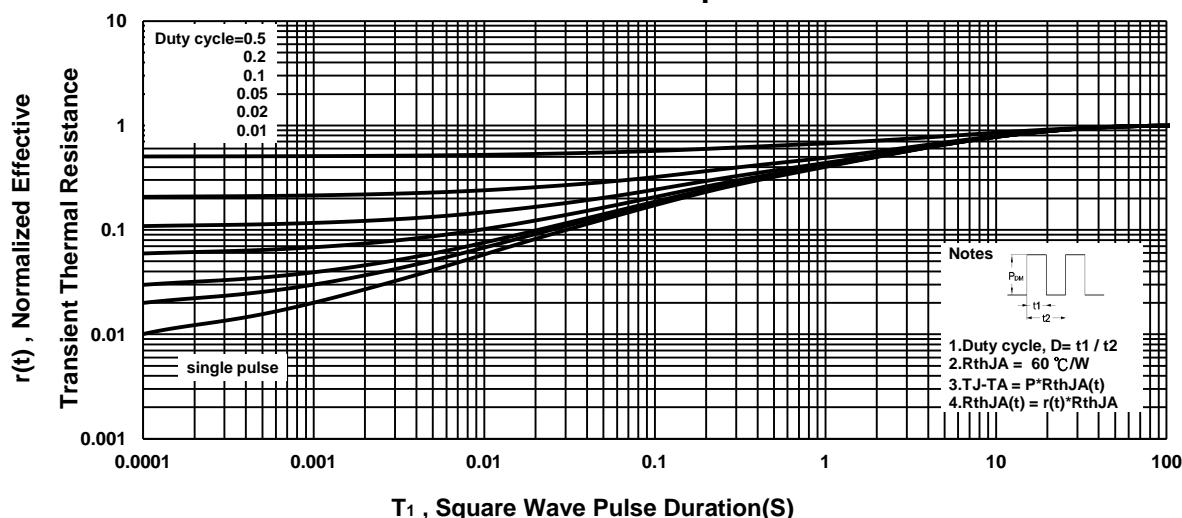


On-Resistance VS Temperature



Capacitance Characteristic



NIKO-SEM**N-Channel Enhancement Mode
Field Effect Transistor****PG1010BK
PDFN 5x6P
Halogen-Free & Lead-Free****Gate charge Characteristics****Source-Drain Diode Forward Voltage****Safe Operating Area****Single Pulse Maximum Power Dissipation****Transient Thermal Response Curve**

NIKO-SEM

**N-Channel Enhancement Mode
Field Effect Transistor**

**PG1010BK
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